

Vishay Siliconix

COMPLIANT

# N-Channel 150-V (D-S) 175 °C MOSFET

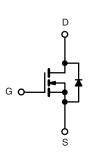
PRODUCT SUMMARY				
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A)		
150	0.052 at V <sub>GS</sub> = 10 V	25		
	0.060 at V <sub>GS</sub> = 6 V	23		



- TrenchFET<sup>®</sup> Power MOSFET
- 175 °C Junction Temperature
- PWM Optimized
- 100 % Rg Tested
- Compliant to RoHS Directive 2002/95/EC

#### **APPLICATIONS**

• Primary Side Switch



N-Channel MOSFET

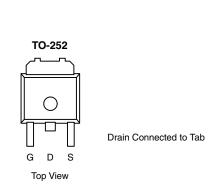
<b>ABSOLUTE MAXIMUM RATINGS</b> $T_A =$	25 °C, unless other	wise noted		
Parameter	Symbol	Limit	Unit	
Drain-Source Voltage		V <sub>DS</sub>	150	v
Gate-Source Voltage		V <sub>GS</sub>	± 20	v
Continuous Durin Coursent (T. 175 00)b	T <sub>C</sub> = 25 °C	L	25	
Continuous Drain Current (T <sub>J</sub> = 175 °C) <sup>b</sup>	T <sub>C</sub> = 125 °C	I <sub>D</sub>	14.5	
Pulsed Drain Current		I <sub>DM</sub>	50	А
Continuous Source Current (Diode Conduction)		۱ <sub>S</sub>	25	
Avalanche Current		I <sub>AR</sub>	25	
Repetitive Avalanche Energy (Duty Cycle $\leq$ 1 %)	L = 0.1 mH	E <sub>AR</sub>	31	mJ
Maximum Dissission	T <sub>C</sub> = 25 °C	P <sub>D</sub>	136 <sup>b</sup>	w
Maximum Power Dissipation	T <sub>A</sub> = 25 °C		3 <sup>a</sup>	vv
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 175	°C

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
lunation to Amhionta	t ≤ 10 s	- R <sub>thJA</sub>	15	18	°C/W	
Junction-to-Ambient <sup>a</sup>	Steady State		40	50		
Junction-to-Case (Drain)		R <sub>thJC</sub>	0.85	1.1		

Notes:

a. Surface Mounted on 1" x 1" FR4 board.

b. See SOA curve for voltage derating.



Ordering Information:

SUD25N15-52-E3 (Lead (Pb)- free)

# SUD25N15-52

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Parameter	Symbol	Test Conditions	Min.	Typ. <sup>a</sup>	Max.	Unit	
Static		· · · · · · · · · · · · · · · · · · ·					
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS}$ = 0 V, I <sub>D</sub> = 250 µA	150			v	
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	2		4		
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS} = 150 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	1		1		
		$V_{DS}$ = 150 V, $V_{GS}$ = 0 V, $T_{J}$ = 125 °C			50	μA	
		$V_{DS} = 150 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 175 ^{\circ}\text{C}$			250	-	
On-State Drain Current <sup>b</sup>	I <sub>D(on)</sub>	$V_{DS} = 5 V, V_{GS} = 10 V$	50			Α	
Drain-Source On-State Resistance <sup>b</sup>		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 5 \text{ A}$		0.042	0.052		
	R <sub>DS(on)</sub>	$V_{GS}$ = 10 V, $I_{D}$ = 5 A, $T_{J}$ = 125 °C			0.109	Ω	
		$V_{GS}$ = 10 V, I <sub>D</sub> = 5 A, T <sub>J</sub> = 175 °C			0.145		
		$V_{GS} = 6 V, I_D = 5 A$		0.047	0.060		
Forward Transconductance <sup>b</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 25 A		40		S	
Dynamic <sup>a</sup>							
Input Capacitance	C <sub>iss</sub>			1725		pF	
Output Capacitance	C <sub>oss</sub>	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 25 V, f = 1 MHz		216			
Reverse Transfer Capacitance	C <sub>rss</sub>			100			
Total Gate Charge <sup>c</sup>	Qg			33	40		
Gate-Source Charge <sup>c</sup>	Q <sub>gs</sub>	$V_{DS} = 75 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 25 \text{ A}$		9		nC	
Gate-Drain Charge <sup>c</sup>	Q <sub>gd</sub>			12			
Gate Resistance	Rg		1		3	Ω	
Turn-On Delay Time <sup>c</sup>	t <sub>d(on)</sub>			15	25	ns	
Rise Time <sup>c</sup>	t <sub>r</sub>	$V_{DD} = 50 \text{ V}, \text{ R}_{\text{L}} = 3 \Omega$ $\text{I}_{\text{D}} \cong 25 \text{ A}, \text{ V}_{\text{GEN}} = 10 \text{ V}, \text{ R}_{\text{g}} = 2.5 \Omega$		70	100		
Turn-Off Delay Time <sup>c</sup>	t <sub>d(off)</sub>			25	40		
Fall Time <sup>c</sup>	t <sub>f</sub>		60		90		
Source-Drain Diode Ratings and Cha	racteristics	Γ <sub>C</sub> = 25 °C			I		
Pulsed Current	I <sub>SM</sub>				50	А	
Diode Forward Voltage <sup>b</sup>	$V_{SD}$	$I_{F} = 25 \text{ A}, V_{GS} = 0 \text{ V}$		0.9	1.5	V	
Source-Drain Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> = 25 A, dl/dt = 100 A/μs		95	140	ns	

Notes:

a. Guaranteed by design, not subject to production testing.

b. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.

c. Independent of operating temperature.

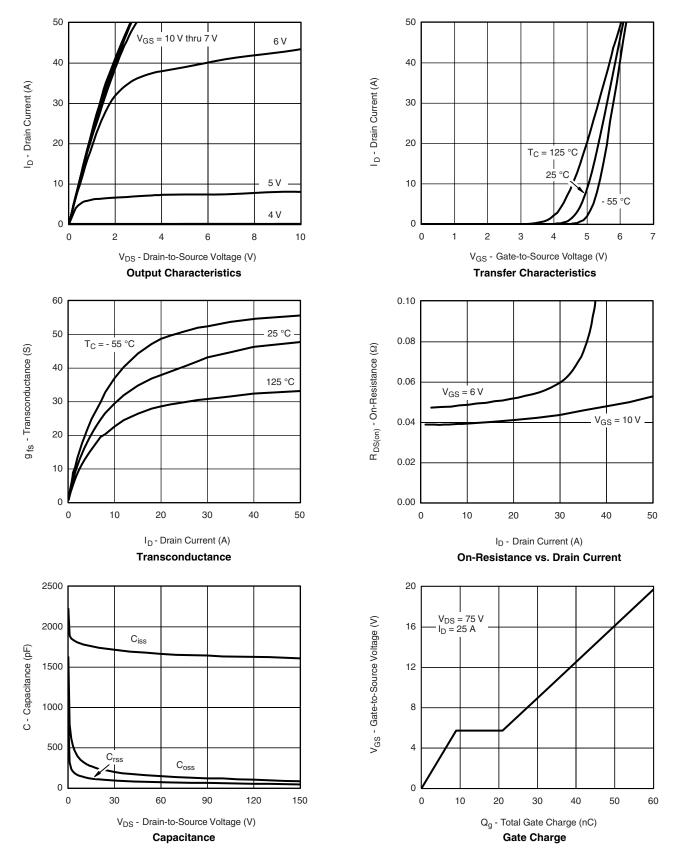
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



# SUD25N15-52

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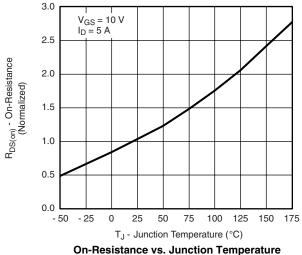
### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



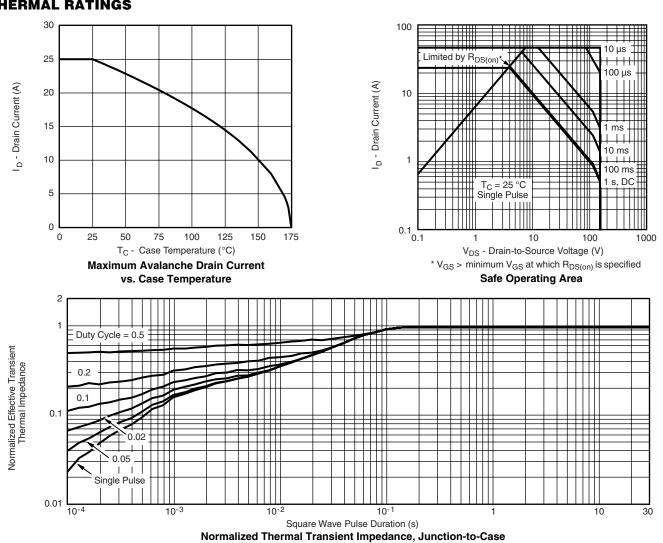
Document Number: 71768 S09-1501-Rev. D, 10-Aug-09

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#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted







100

10

1

0

0.3

T<sub>J</sub> = 150 °C

0.6

V<sub>SD</sub> - Source-to-Drain Voltage (V)

Source-Drain Diode Forward Voltage

I<sub>S</sub> - Source Current (A)

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T<sub>J</sub> = 25 °C

0.9

1.2



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